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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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**QT-Brightek Side View LED Series**

**0602 Side View LED**

**Part No.: QBLP617-YG**

Product: QBL617-YG	Date: September 25, 2014	Page 1 of 9
	Version# 1.0	

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## Introduction

**Feature:**

- Water clear lens
- Package in tape and reel
- Side View Ultra bright 0602 LED package
- GaP technology
- 140° Viewing Angle

**Description:**

These ultra bright side view 0602 LEDs have a height profile of 0.6mm. With higher packing density and smaller footprint, these LEDs are ideal for smaller equipment and miniature application.

**Application:**

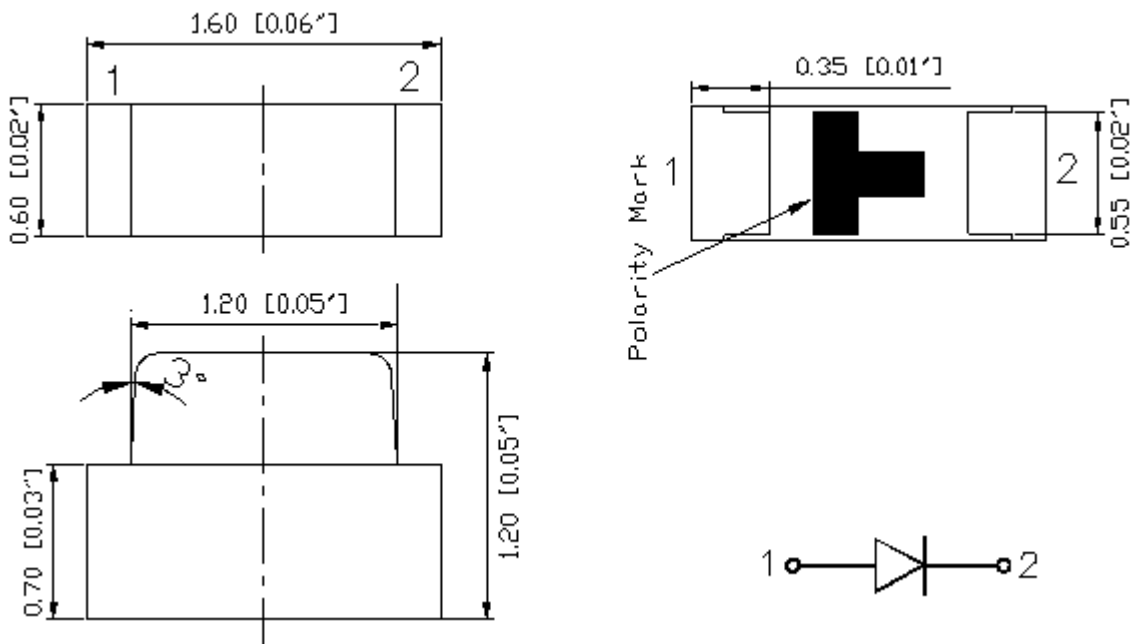
- Status indication
- Back lighting application
- General Use

**Certification & Compliance:**

- TS16949
- ISO9001
- RoHS Compliant



**Dimension:**



Units: mm / tolerance = +/-0.1mm



**Electrical / Optical Characteristic (Ta=25 °C)**

Product	Color	I <sub>F</sub> (mA)	V <sub>F</sub> (V)		λ <sub>D</sub> (nm)			I <sub>V</sub> (mcd)	
			Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.
QBLP617-YG	Yellow Green	20	2.0	2.5	565	570	576	5.0	15

**Absolute Maximum Rating**

Material	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)*	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)	T <sub>SOL</sub> (°C)**
GaP	75	30	125	5	-40 to +80	-40 to +85	260

\*Duty 1/8 @ 1kHz

\*\*IR Reflow for no more than 10 sec @ 260 °C

**Forward Voltage V<sub>F</sub> @ I<sub>F</sub>=20mA**

Bin	Min.	Max.	Unit
□	1.7	2.5	V

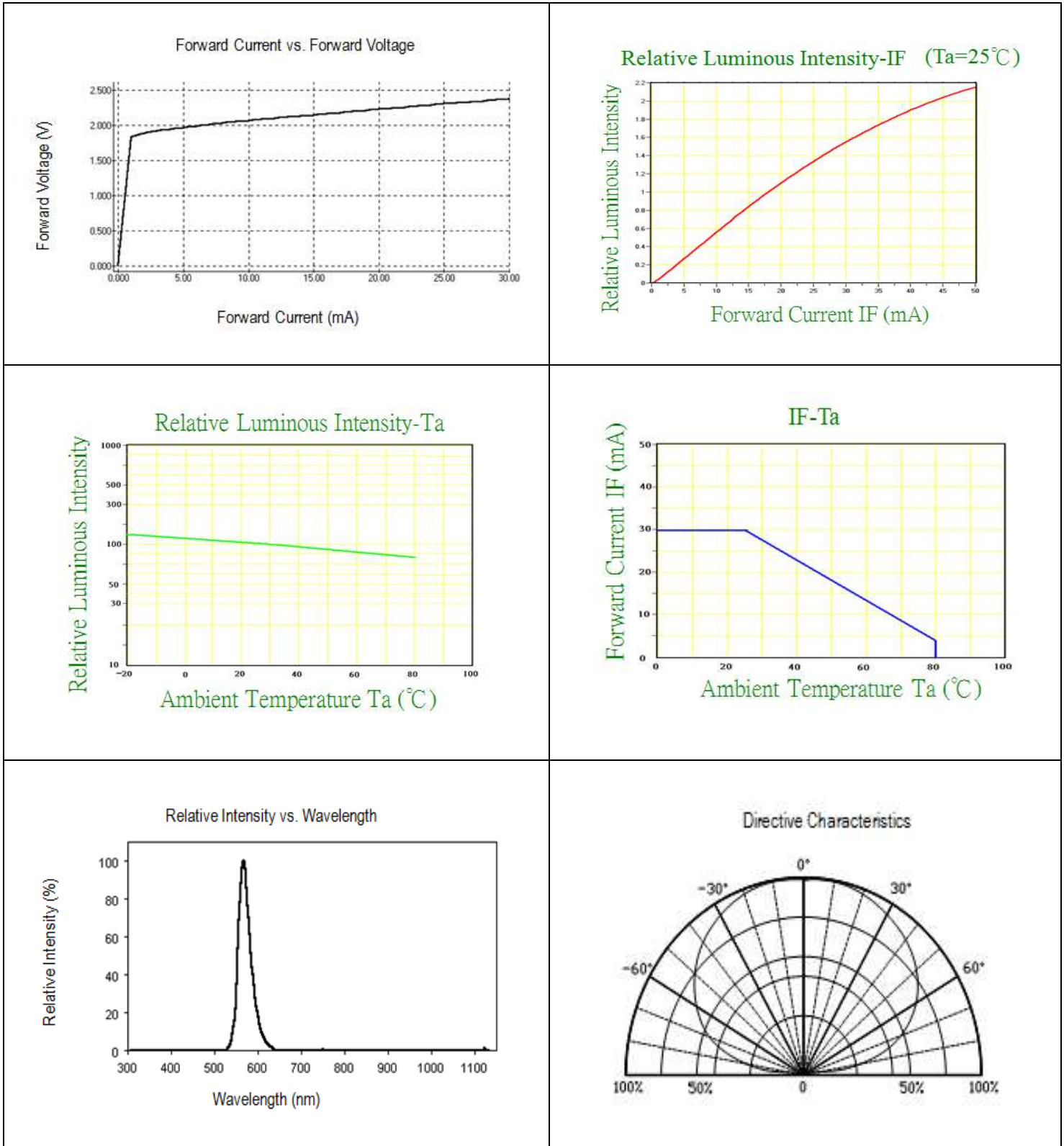
**Luminous Intensity I<sub>V</sub> @ I<sub>F</sub>=20mA**

Bin	Min.	Max.	Unit
8	5.0	8.0	mcd
9	8.0	12.5	
A	12.5	16	
B	16	20	
C	20	25	

**Dominant Wavelength λ<sub>D</sub> @ I<sub>F</sub>=20mA**

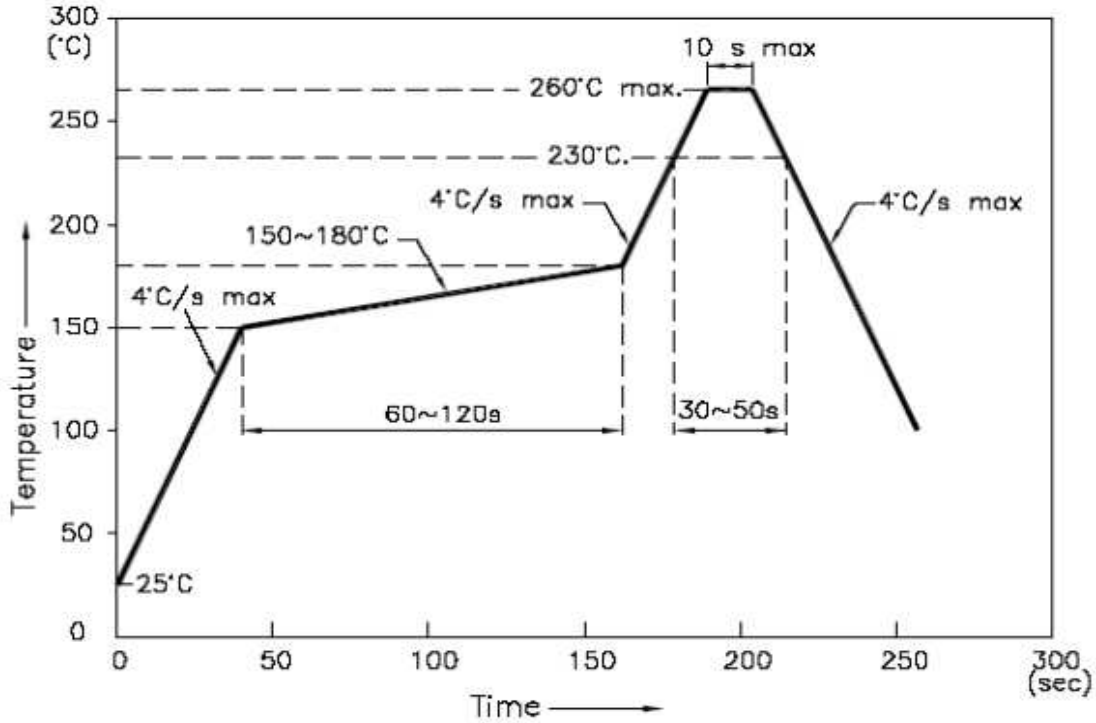
Bin	Min.	Max.	Unit
h	565	568	nm
i	568	572	
j	572	576	

## Characteristic Curves

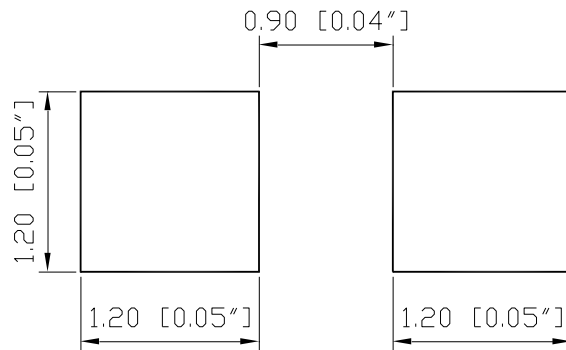


### Solder Profile & Footprint

- Recommended tin solder specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



### Recommended Pad Layout

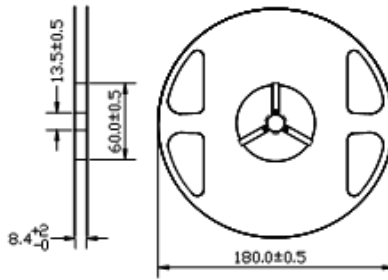


Units: mm

Tolerance: ± 0.1mm

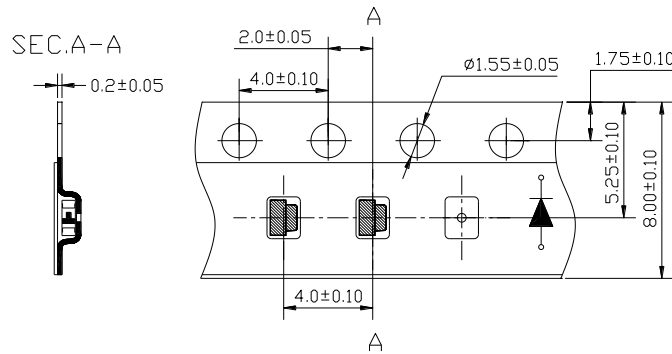
## Packing

### Reel Dimension:



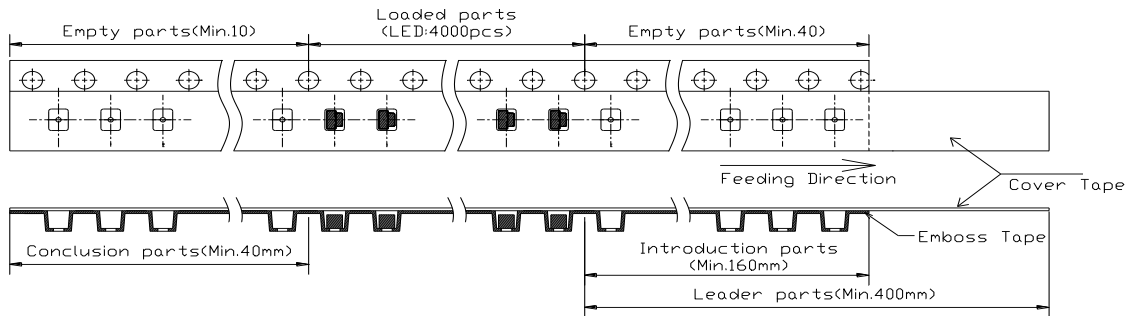
Unit: mm

### Tape Dimension:

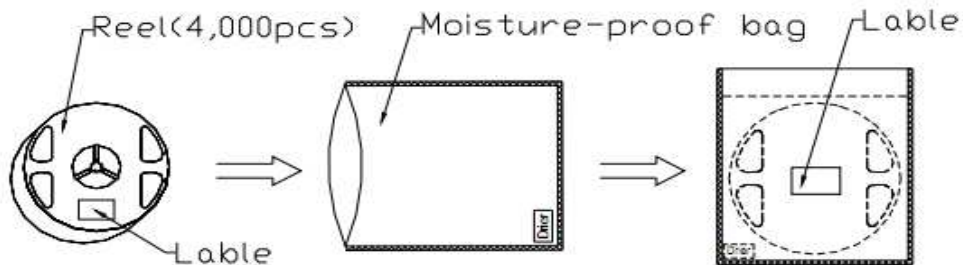


Unit: mm

### Arrangement of Tape:



### Packaging Specifications:





**Labeling**

Part No: \_\_\_\_\_  
 Customer P/N: \_\_\_\_\_  
 Item: \_\_\_\_\_  
 Q'ty: \_\_\_\_\_  
 Vf: \_\_\_\_\_  
 Iv: \_\_\_\_\_  
 WI: \_\_\_\_\_  
 Date: \_\_\_\_\_

**Made in China****Ordering Information**

Part #	Orderable Part #	Spec Range	Quantity per reel
QBLP617-YG	QBLP617-YG	Iv=15mcd typ. @ I <sub>F</sub> =20mA, λ <sub>D</sub> =565nm ~ 576nm	4,000 units

## Revision History

Description:	Revision #	Revision Date
New Release of QBLP617-YG	V1.0	09/25/2014

## Disclaimer

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.